



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): WonSun Shin et al.

Assignee: Amkor Technology, Inc.

Title: STACKABLE SEMICONDUCTOR PACKAGE HAVING
SEMICONDUCTOR CHIP WITHIN CENTRAL THROUGH HOLE OF
SUBSTRATE

Serial No.: 10/803,333 Filed: March 17, 2004

Examiner: Luu, Chuong A. Group Art Unit: 2818

Docket No.: GK0012-1C

Monterey, CA
June 3, 2005

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

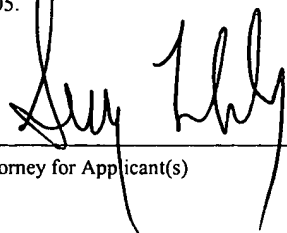
REQUEST FOR CHANGE OF ATTORNEY DOCKET NUMBER

Dear Sir:

Please change the Attorney Docket Number in the above application to "GK0012-1C". Please use Attorney Docket Number "GK0012-1C" in all future correspondence with Applicant's attorney.

CERTIFICATE OF MAILING

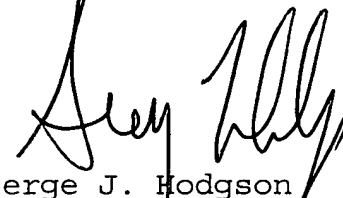
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on June 3, 2005.



Attorney for Applicant(s)

June 3, 2005
Date of Signature

Respectfully submitted,


Serge J. Hodgson
Attorney for Applicant(s)
Reg. No. 40,017
(831) 655-0880